

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/551,843 Confirmation No. : 5817
First Named Inventor : Tadahiro OHMI
Filed : September 27, 2006
TC/A.U. : 2812
Examiner : Grant S. Withers

Docket No. : 010986.56896US
Customer No. : 23911

Title : Semiconductor Device and Method for Manufacturing the Same

**SUBMISSION OF ENGLISH-LANGUAGE TRANSLATION AND
STATEMENT THAT TRANSLATION IS ACCURATE**

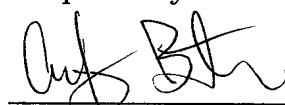
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants submit herewith an English-language translation of Japanese Patent Application No. 2003-100170 filed April 3, 2003, together with a verified statement of the translator indicating that the translation is accurate.

Respectfully submitted,

November 12, 2008



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